

#### **CLOCK DISTRIBUTION CIRCUIT**

#### IDT6T39007A

### **Description**

The IDT6T39007A is a low-power, four output clock distribution circuit. The device takes a TCXO or 1.8 V to 2.5 V LVCMOS input and generates four high-quality LVDS outputs, and two programmable divided outputs.

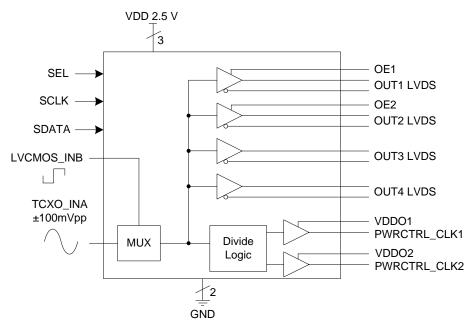
It includes a redundant input with automatic glitch-free switching when the primary reference is removed. The primary input may be selected by the user by pulling the SEL pin low or high. If the primary input is removed and brought back, it will not be re-selected until 1024 cycles have passed.

The IDT6T39007A specifically addresses the needs of handheld applications in both performance and package size. The device is packaged in a small 4mm x 4mm 24-pin QFN, allowing optimal use for limited board space.

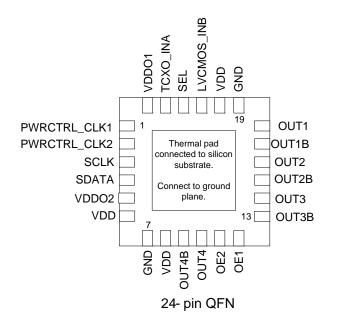
#### **Features**

- Packaged in 24-pin QFN
- TCXO sine wave input
- +2.5 V operating voltage
- Four buffered LVDS outputs
- Two programmable outputs for power control up to 3.0 V LVCMOS levels based on VDDO1/VDDO2
- Individual output enables controlled via I<sup>2</sup>C or OEx
- Pb-free, RoHS compliant package
- Industrial temperature range (-40°C to +85°C)

### **Block Diagram**



# **Pin Assignment**



# **SEL Pin Configuration Table**

| SEL | Primary Input |
|-----|---------------|
| 0   | LVCMOS_INB    |
| 1   | TCXO_INA      |

# **OE Pin Configuration Table**

| OEx | OUTx LVDS |  |  |  |  |  |  |
|-----|-----------|--|--|--|--|--|--|
| 0   | Disabled  |  |  |  |  |  |  |
| 1   | Enabled   |  |  |  |  |  |  |

# **Pin Descriptions**

| Pin<br>Number | Pin<br>Name  | Pin<br>Type | Pin Description  |
|---------------|--------------|-------------|--|
| 1             | PWRCTRL_CLK1 | Output      | Programmable power control output 1. See I <sup>2</sup> C table.                     |
| 2             | PWRCTRL_CLK2 | Output      | Programmable power control output 2. See I <sup>2</sup> C table.                     |
| 3             | SCLK         | Input       | I <sup>2</sup> C clock input.  |
| 4             | SDATA        | Input       | I <sup>2</sup> C data input.   |
| 5             | VDDO2        | Power       | Connect to +3.0 V.   |
| 6             | VDD          | Power       | Connect to +2.5 V.   |
| 7             | GND          | Power       | Connect to ground.   |
| 8             | VDD          | Power       | Connect to +2.5 V.   |
| 9             | OUT4B        | Output      | Buffered LVDS output. Outputs tri-state when disabled.                               |
| 10            | OUT4         | Output      | Buffered LVDS output. Outputs tri-state when disabled.                               |
| 11            | OE2          | Input       | Output enable control for OUT2 LVDSpins. Internal pull-up resistor. See table above. |
| 12            | OE1          | Input       | Output enable control for OUT1 LVDSpins. Internal pull-up resistor. See table above. |
| 13            | OUT3B        | Output      | Buffered LVDS output. Outputs tri-state when disabled.                               |
| 14            | OUT3         | Output      | Buffered LVDS output. Outputs tri-state when disabled.                               |
| 15            | OUT2B        | Output      | Buffered LVDS output. Outputs tri-state when disabled.                               |

| Pin<br>Number | Pin<br>Name | Pin<br>Type | Pin Description  |
|---------------|-------------|-------------|--|
| 16            | OUT2        | Output      | Buffered LVDS output. Outputs tri-state when disabled.                     |
| 17            | OUT1B       | Output      | Buffered LVDS output. Outputs tri-state when disabled.                     |
| 18            | OUT1        | Output      | Buffered LVDS output. Outputs tri-state when disabled.                     |
| 19            | GND         | Power       | Connect to ground.   |
| 20            | VDD         | Power       | Connect to +2.5 V.   |
| 21            | LVCMOS_INB  | Input       | Connect to primary LVCMOS input INB. See table above.                      |
| 22            | SEL         | Input       | Select pin for primary inputs. See table above. Internal pull-up resistor. |
| 23            | TCXO_INA    | Input       | Connect to TCXO input.   |
| 24            | VDDO1       | Power       | Connect to +3.0 V.   |

## General I<sup>2</sup>C Serial Interface

#### **How to Write:**

- Controller (host) sends a start bit
- Controller (host) sends the write address D4<sub>(H)</sub>
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location =N
- IDT clock will acknowledge
- Controller (host) sends the data byte count = X
- IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N + X 1 (see Note 2)
- IDT clock will acknowledge each byte one at a time
- · Controller (host) sends a Stop bit

| Index Block Write Operation |                          |            |                      |  |  |  |
|-----------------------------|--------------------------|------------|----------------------|--|--|--|
| Contro                      | ller (Host)              |            | IDT (Slave/Receiver) |  |  |  |
| Т                           | starTbit                 |            |                      |  |  |  |
| Slave Ac                    | ldress D4 <sub>(H)</sub> |            |                      |  |  |  |
| WR                          | WRite                    |            |                      |  |  |  |
|                             |                          |            | ACK                  |  |  |  |
| Beginnir                    | ng Byte = N              |            |                      |  |  |  |
|                             |                          |            | ACK                  |  |  |  |
| Data Byt                    | e Count = X              |            |                      |  |  |  |
|                             |                          |            | ACK                  |  |  |  |
| Beginnir                    | ng Byte = N              |            |                      |  |  |  |
|                             |                          |            | ACK                  |  |  |  |
|                             | 0                        | — X<br>— В |                      |  |  |  |
|                             | 0                        | Y          | 0                    |  |  |  |
|                             | 0                        | T<br>E     | 0                    |  |  |  |
|                             |                          | 0          |                      |  |  |  |
| Byte                        | N + X - 1                |            |                      |  |  |  |
|                             |                          |            | ACK                  |  |  |  |
| Р                           | stoP bit                 |            |                      |  |  |  |

#### How to Read:

- Controller (host) sends a start bit
- Controller (host) sends the write address D4<sub>(H)</sub>
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location =N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address D5<sub>(H)</sub>
- IDT clock will acknowledge
- Controller (host) sends the data byte count = X
- IDT clock sends Byte N + X 1
- IDT clock sends Byte 0 through byte X (if X<sub>(H)</sub> was written to byte 8)
- · Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

| Index Block Read Operation |                             |                      |                     |  |  |  |
|----------------------------|-----------------------------|----------------------|---------------------|--|--|--|
| Co                         | ntroller (Host)             | IDT (Slave/Receiver) |                     |  |  |  |
| Т                          | starTbit                    |                      |                     |  |  |  |
| Slav                       | e Address D4 <sub>(H)</sub> |                      |                     |  |  |  |
| WR                         | WRite                       |                      |                     |  |  |  |
|                            |                             |                      | ACK                 |  |  |  |
| Beg                        | inning Byte = N             |                      |                     |  |  |  |
|                            |                             |                      | ACK                 |  |  |  |
| RT                         | Repeat starT                |                      |                     |  |  |  |
| Slav                       | e Address D5 <sub>(H)</sub> |                      |                     |  |  |  |
| RD                         | ReaD                        |                      |                     |  |  |  |
|                            |                             |                      | ACK                 |  |  |  |
|                            |                             |                      |                     |  |  |  |
|                            |                             |                      | Data Byte Count = X |  |  |  |
|                            | ACK                         |                      |                     |  |  |  |
|                            |                             |                      | Beginning Byte N    |  |  |  |
|                            | ACK                         | X                    |                     |  |  |  |
|                            |                             | B                    | 0                   |  |  |  |
|                            | 0                           | Υ                    | 0                   |  |  |  |
| 0                          |                             |                      | 0                   |  |  |  |
| 0                          |                             |                      |                     |  |  |  |
|                            |                             |                      | Byte N + X - 1      |  |  |  |
| N                          | Not acknowledge             |                      |                     |  |  |  |
| Р                          | stoP bit                    |                      |                     |  |  |  |

# I<sup>2</sup>C Address

The IDT6T39007A is a slave-only device that supports block read and block write protocol using a single 7 bit address and read/write bit. A block write  $(D4_{(H)})$  or block read  $(D5_{(H)})$  is made up of seven (7) bits and one (1) read/write bit.

| <b>A</b> 6 | <b>A</b> 5 | <b>A</b> 4 | А3 | A2 | <b>A</b> 1 | A0 | R/W# |
|------------|------------|------------|----|----|------------|----|------|
| 1          | 1          | 0          | 1  | 0  | 1          | 0  | Х    |

In applications where the indexed block write and block read are used, the dummy byte (bit 11-18) functions as a register-offset (8 bits) pointer.

### **Byte 0: Control Register**

| Bit | Description | Туре | Power Up<br>Condition | Output(s) Affected | Notes                   |
|-----|-------------|------|-----------------------|--------------------|-------------------------|
| 7   | Reserved    | R    | Undefined             | Not applicable     |                         |
| 6   | Reserved    | R    | Undefined             | Not applicable     |                         |
| 5   | OE for OUT3 | RW   | 1                     | LVDS clock output  | 1=enabled<br>0=disabled |
| 4   | OE for OUT4 | RW   | 1                     | LVDS clock output  | 1=enabled<br>0=disabled |
| 3   | Reserved    | R    | Undefined             | Not applicable     |                         |
| 2   | Reserved    | R    | Undefined             | Not applicable     |                         |
| 1   | Reserved    | R    | Undefined             | Not applicable     |                         |
| 0   | Reserved    | R    | Undefined             | Not applicable     |                         |

# **Byte 1: Control Register**

| Bit | Description                    | Туре | Power Up<br>Condition | Output(s) Affected | Notes   |
|-----|--------------------------------|------|-----------------------|--------------------|---|
| 7   | PWRCTRL_CLK1 Divider SEL bit 7 | RW   | 0                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |
| 6   | PWRCTRL_CLK1 Divider SEL bit 6 | RW   | 0                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |
| 5   | PWRCTRL_CLK1 Divider SEL bit 5 | RW   | 0                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |
| 4   | PWRCTRL_CLK1 Divider SEL bit 4 | RW   | 0                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |
| 3   | PWRCTRL_CLK1 Divider SEL bit 3 | RW   | 1                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |
| 2   | PWRCTRL_CLK1 Divider SEL bit 2 | RW   | 1                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |
| 1   | PWRCTRL_CLK1 Divider SEL bit 1 | RW   | 1                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |
| 0   | PWRCTRL_CLK1 Divider SEL bit 0 | RW   | 1                     | PWRCTRL_CLK1       | Default is /15 to<br>get 866.666 kHz<br>from 13 MHz |

# **Byte 2: Control Register**

| Bit | Description                    | Type | Power Up<br>Condition | Output(s) Affected | Notes  |
|-----|--------------------------------|------|-----------------------|--------------------|--|
| 7   | PWRCTRL_CLK2 Divider SEL bit 7 | RW   | 0                     | PWRCTRL_CLK2       | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |
| 6   | PWRCTRL_CLK2 Divider SEL bit 6 | RW   | 0                     | PWRCTRL_CLK2       | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |
| 5   | PWRCTRL_CLK2 Divider SEL bit 5 | RW   | 1                     | PWRCTRL_CLK2       | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |
| 4   | PWRCTRL_CLK2 Divider SEL bit 4 | RW   | 0                     | PWRCTRL_CLK1       | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |
| 3   | PWRCTRL_CLK2 Divider SEL bit 3 | RW   | 1                     | PWRCTRL_CLK1       | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |

| 2 | PWRCTRL_CLK2 Divider SEL bit 2 | RW | 1 | PWRCTRL_CLK1 | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |
|---|--------------------------------|----|---|--------------|--|
| 1 | PWRCTRL_CLK2 Divider SEL bit 1 | RW | 1 | PWRCTRL_CLK1 | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |
| 0 | PWRCTRL_CLK2 Divider SEL bit 0 | RW | 0 | PWRCTRL_CLK1 | Default is /46 to<br>get 282.6kHz<br>from 13 MHz |

# **Byte 3: Control Register**

| Bit    | Description | Туре | Power Up<br>Condition | Output(s) Affected | Notes |
|--------|-------------|------|-----------------------|--------------------|-------|
| 7 to 0 | Reserved    | R    | Undefined             | Not applicable     |       |

# **Byte 4 through 5: Control Register**

| Bit    | Description | Туре | Power Up<br>Condition | Output(s) Affected | Notes |
|--------|-------------|------|-----------------------|--------------------|-------|
| 7 to 0 | Reserved    | R    | Undefined             | Not applicable     |       |

# **Byte 6: Control Register**

| Bit | Description       | Туре | Power Up           | Output(s) Affected | Notes |
|-----|-------------------|------|--------------------|--------------------|-------|
| 7   | Revision ID bit 3 | R    | 0                  | Not applicable     |       |
| 6   | Revision ID bit 2 | R    | R 0 Not applicable |                    |       |
| 5   | Revision ID bit 1 | R    | 0                  | 0 Not applicable   |       |
| 4   | Revision ID bit 0 | R    | 0                  | Not applicable     |       |
| 3   | Vendor ID bit 3   | R    | 0                  | Not applicable     |       |
| 2   | Vendor ID bit 2   | R    | 0 Not applicable   |                    |       |
| 1   | Vendor ID bit 1   | R    | 0                  | Not applicable     |       |
| 0   | Vendor ID bit 0   | R    | 1                  | Not applicable     |       |

### **Applications Information**

### **External Components**

A minimum number of external components are required for proper operation.

#### **Decoupling Capacitors**

Decoupling capacitors of 0.01  $\mu F$  should be connected between VDD and GND as close to the device as possible. Do not share ground vias between components. Route power from power source through the capacitor pad and then into IDT pin.

#### **PCB Layout Recommendations**

For optimum device performance and lowest output phase noise, the following guidelines should be observed.

- 1. Each  $0.01\mu F$  decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible.
- 2. No vias should be used between decoupling capacitor and VDD pin.
- 3. The PCB trace to VDD pin should be kept as short as possible, as should the PCB trace to the ground via. Distance of the ferrite bead and bulk decoupling from the device is less critical.
- 4. An optimum layout is one with all components on the same side of the board, minimizing vias through other signal layers (any ferrite beads and bulk decoupling capacitors can be mounted on the back). Other signal traces should be routed away from the IDT6T39007A. This includes signal traces just underneath the device, or on layers adjacent to the ground plane layer used by the device.

## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the IDT6T39007A. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| Item                              | Rating              |  |  |
|-----------------------------------|---------------------|--|--|
| Max Supply Voltage, VDD           | 5 V                 |  |  |
| LVCMOS_INB, SCLK and SDATA Inputs | -0.5 V to +3.3 V    |  |  |
| All Other Inputs and Outputs      | -0.5 V to VDD+0.5 V |  |  |
| Ambient Operating Temperature     | -40 to +85° C       |  |  |
| Storage Temperature               | -65 to +150° C      |  |  |
| Junction Temperature              | 125° C              |  |  |
| Peak Soldering Temperature        | 260° C              |  |  |

## **Recommended Operation Conditions**

| Parameter   | Min.  | Тур. | Max.  | Units |
|---|-------|------|-------|-------|
| Ambient Operating Temperature                     | -40   |      | +85   | °C    |
| Power Supply Voltage (measured in respect to GND) | +2.25 | +2.5 | +2.75 | V     |
| Output Supply Voltage (VDDO1, VDDO2)              | VDD   | +3.0 | +3.15 | V     |

### **DC Electrical Characteristics**

Unless otherwise specified, VDD =2.5 V ±10%, VDDO1 = VDDO2 = 3.0 V ±5%, Ambient Temp. -40 to +85° C

| Parameter                 | Symbol          | Conditions                               | Min.     | Тур. | Max.     | Units |
|---------------------------|-----------------|--|----------|------|----------|-------|
| Operating Supply Voltage  | VDD             |  | +2.25    | +2.5 | +2.75    | V     |
| Output Supply Voltage     | VDDO            | VDDO1, VDDO2                             | VDD      | 3.0  | 3.15     | V     |
| Input High Voltage        | V <sub>IH</sub> | SEL, OEx, LVCMOS_INB                     | 0.75xVDD |      |          | V     |
|                           |                 | SCLK and SDATA                           | 0.7xVDD  |      |          |       |
| Input Low Voltage         | V <sub>IL</sub> | SEL, OEx, LVCMOS_INB                     |          |      | 0.35xVDD | V     |
|                           |                 | SCLK and SDATA                           |          |      | 0.3xVDD  |       |
| High-Level Output Voltage | V <sub>OH</sub> | I <sub>OH</sub> = -4 mA                  | 1.7      |      |          | V     |
| Low-Level Output Voltage  | $V_{OL}$        | I <sub>OL</sub> = 4 mA                   |          |      | 0.7      | V     |
| Operating Supply Current  | IDD             | No load, all outputs switching at 13 MHz |          | 15   | 18       | mA    |
|                           |                 | All outputs disabled                     |          | TBD  |          | mA    |
| Short Circuit Current     | I <sub>OS</sub> | Single-ended clocks                      |          | ±70  |          | mA    |

| Parameter                   | Symbol          | Conditions               | Min. | Тур. | Max. | Units |
|-----------------------------|-----------------|--------------------------|------|------|------|-------|
| Output Impedance            | Z <sub>O</sub>  | All clock outputs, OEx=1 |      | 15   |      | Ω     |
| Internal Pull-Up Resistance | R <sub>pu</sub> | SEL, OEx                 |      | 500  |      | kΩ    |
| Input Capacitance           | C <sub>IN</sub> | All input pins           |      | 6    |      | pF    |

### **AC Electrical Characteristics - Single-Ended Outputs**

Unless otherwise stated, VDD =2.5 V ±10%, VDDO1 = VDDO2 = 3.0 V ±5%, Ambient Temp. -40 to +85° C

| Parameter                              | Symbol          | Conditions  | Min. | Тур. | Max. | Units |
|--|-----------------|---|------|------|------|-------|
| Input Frequency                        | F <sub>IN</sub> |   | 12.6 | 13   | 13.4 | MHz   |
| Variance Input Frequencies             |                 | LVCMOS_INB, TCXO_INA,<br>Note 2                   |      |      | 0.4  | MHz   |
| Time Switch Clock Inputs               |                 | LVCMOS_INB, TCXO_INA,<br>Note 3                   |      | 80   |      | μs    |
| TCXO Input Swing                       |                 | TCXO_INA  | ±100 |      | ±900 | mV    |
| Output Frequency Error                 |                 |   |      | 0    |      | ppm   |
| Output Rise Time                       | t <sub>OR</sub> | 20% to 80%, Note 1                                |      | 1    | 1.5  | ns    |
| Output Fall Time                       | t <sub>OF</sub> | 80% to 20%, Note 1                                |      | 1    | 1.5  | ns    |
| Output Clock Duty Cycle                |                 | Measured at VDDO/2, Note 1                        | 45   | 50   | 55   | %     |
| Output Enable time                     |                 | OE goes high, output within 1% of final frequency |      |      | 1    | ms    |
| Clock Stabilization Time from Power Up |                 | Power up, output within 1% of final frequency     |      | 3    | 10   | ms    |

Note 1: CL = 8 pF.

Note 2: Delta from 13 MHz.

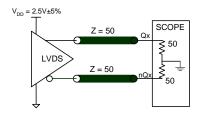
Note 3: By removing primary input and then bringing back primary input.

# **AC Electrical Characteristics - LVDS Outputs**

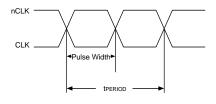
Unless otherwise stated, **VDD = 2.5 V ±10%**, Ambient Temperature -40 to +85° C

| Parameter                                       | Conditions                          | Min.  | Тур. | Max.  | Units |
|---|-------------------------------------|-------|------|-------|-------|
| Differential Output Voltages   V <sub>OD</sub>  | $R_L = 100\Omega$                   | 250   | 350  | 450   | mV    |
| ΔV <sub>OD</sub>                                | V <sub>OD</sub> Magnitude<br>Change | -40   | 0    | 40    | mV    |
| Offset Voltage (V <sub>OS</sub> )               |                                     | 1.125 | 1.25 | 1.375 | V     |
| Output CLock Duty Cycle                         | Measured at V <sub>OS</sub>         | 45    | 50   | 55    | %     |
| ΔV <sub>OS</sub>                                | V <sub>OS</sub> Magnitude<br>Change |       | 3    | 25    | mV    |
| Output Short Circuit Current (I <sub>OS</sub> ) |                                     |       | -10  |       | mA    |
| Output Rise Time                                | 20% to 80%, $R_L = 100\Omega$       |       | 0.5  | 1.0   | ns    |
| Output Fall Time                                | 20% to 80%, $R_L = 100\Omega$       |       | 0.5  | 1.0   | ns    |

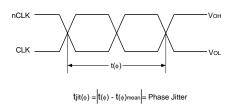
### **Parameter Measurement Information**



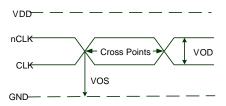
2.5V OUTPUT LOAD AC TEST CIRCUIT



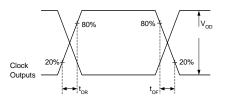
tpw & tperiod



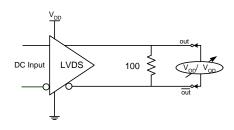
PHASE JITTER



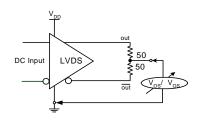
DIFFERENTIAL INPUT LEVEL



OUTPUT RISE/FALL TIME



 ${\rm V_{OD}}$  SETUP



 ${\rm V_{OS}}$  SETUP

# **Marking Diagram**



#### Notes:

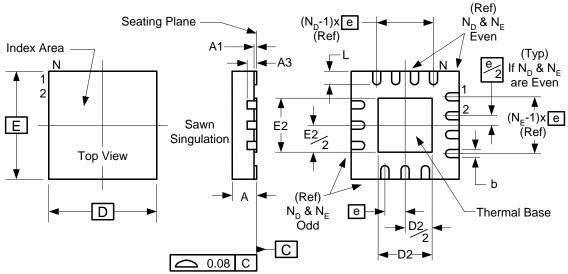
- 1. YYWW is the last two digits of the year and week that the part was assembled.
- 2. "\$" is the assembly mark code.
- 3. "G" after the two-letter package code designates RoHS compliant package.
- 4. "I" at the end of part number indicates industrial temperature range.
- 5. Bottom marking: country of origin if not USA.

### **Thermal Characteristics**

| Parameter                           | Symbol            | Conditions       | Min. | Тур. | Max. | Units |
|-------------------------------------|-------------------|------------------|------|------|------|-------|
| Thermal Resistance Junction to      | $\theta_{JA}$     | Still air        |      | 29.1 |      | ° C/W |
| Ambient                             | $\theta_{JA}$     | 1 m/s air flow   |      | 22.8 |      | ° C/W |
|                                     | $\theta_{JA}$     | 2.5 m/s air flow |      | 21.0 |      | ° C/W |
| Thermal Resistance Junction to Case | $\theta_{\sf JC}$ |                  |      | 41.8 |      | ° C/W |

### Package Outline and Package Dimensions (24-pin QFN)

Package dimensions are kept current with JEDEC Publication No. 95



|                | neters      |          |  |
|----------------|-------------|----------|--|
| Symbol         | Min         | Max      |  |
| Α              | 0.80        | 1.00     |  |
| A1             | 0           | 0.05     |  |
| A3             | 0.25 Re     | eference |  |
| b              | 0.18        | 0.30     |  |
| е              | 0.50 BASIC  |          |  |
| N              | 2           | 24       |  |
| N <sub>D</sub> | 6           |          |  |
| N <sub>E</sub> | 6           |          |  |
| D x E BASIC    | 4.00 x 4.00 |          |  |
| D2             | 2.3         | 2.55     |  |
| E2             | 2.3         | 2.55     |  |
| L              | 0.30        | 0.50     |  |

# **Ordering Information**

| Part / Order Number | Marking     | Shipping Packaging | Package    | Temperature   |
|---------------------|-------------|--------------------|------------|---------------|
| 6T39007ANLGI        | see page 13 | Tray               | 24-pin QFN | -40 to +85° C |
| 6T39007ANLGI8       |             | Tape and Reel      | 24-pin QFN | -40 to +85° C |

#### "G" after the two-letter package code are the Pb-Free configuration and are RoHS compliant.

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### **Revision History**

| Rev. | Originator | Date     | Description of Change            |  |
|------|------------|----------|----------------------------------|--|
| Н    | RDW        | 02/22/12 | . Added device top-side marking. |  |
|      |            |          |                                  |  |
|      |            |          |                                  |  |
|      |            |          |                                  |  |
|      |            |          |                                  |  |

IDT6T39007A CLOCK DISTRIBUTION CIRCUIT

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